Docket No.: 67162-021 PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of : Customer Number: 20277

Ryu MAKABE, et al. : Confirmation Number:

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Serial No.: : Group Art Unit:

Filed: September 16, 2003 : Examiner: Unknown

For: SEMICONDUCTOR WAFER, SEMICONDUCTOR CHIP AND DICING METHOD OF

A SEMICONDUCTOR WAFER

## INFORMATION DISCLOSURE STATEMENT

Mail Stop IDS Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In accordance with the provisions of 37 C.F.R. 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the documents listed on the attached form PTO-1449. It is respectfully requested that the documents be expressly considered during the prosecution of this application, and that the documents be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

This Information Disclosure Statement is being filed within three months of the U.S. filing date OR before the mailing date of a first Office Action on the merits. No certification or fee is required.

## Serial No.:

Please charge any shortage in fees due in connection with the filing of this paper, including extension of time fees, to Deposit Account 500417 and please credit any excess fees to such deposit account.

Respectfully submitted,

MCDERMOTT, WILL & EMERY

Stephen A. Becker Registration No. 26,527

600 13<sup>th</sup> Street, N.W. Washington, DC 20005-3096 (202) 756-8000 SAB:tlb

Facsimile: (202) 756-8087 **Date: September 16, 2003** 

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					APPLICANT Ryu MAKABE, et	APPLICANT Ryu MAKABE, et al.				
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				U.S. PATE	NT DOCUMENTS			3		
EXAMINER'S		1	Document Number	Publication Date	Name of Patentee or Applicant of Cited			Pages, Columns, Lines, Where		
INITIALS	CITE NO.	Number-Kind Code2 (# known)		MM-DD-YYY	Document			Relevant Passages or Relevant Figures Appear		
		US	5,982,042	11/09/1999	Nakamura			Corresponding to JP 9-2	52034	
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			JP 9-252034	09/22/1997	MITSUBISHI ELECTRIC CORP (JP)			(Japan w/English Abstract)		
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<sup>\*</sup>EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

1 Applicant's unique citation designation number (optional). 2 Applicant is to place a check mark here if English language Translation is attached.